

## Dual N-Channel Enhancement Mode MOSFET

## General Description

The CMSC30DN03 is a high performance trench Dual N-channel MOSFET which utilizes extremely high cell density to provide low  $R_{DS(on)}$  and gate charge characteristics. It is ideally suited to support synchronous buck converter applications.

## Features

- Low ON-resistance.
- Improved  $dv/dt$  capability
- Fast switching
- RoHS Compliant

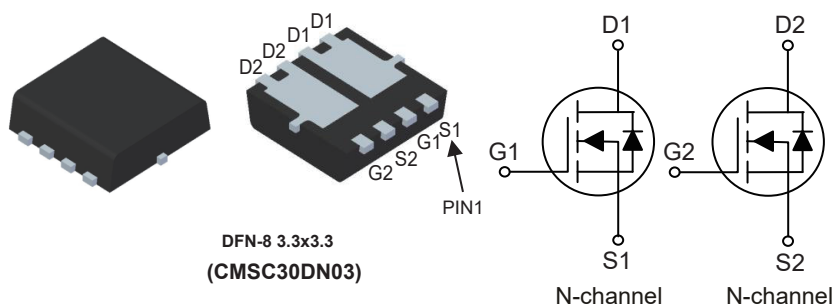
## Product Summary

| BVDSS | $R_{DS(on)}$ | ID  |
|-------|--------------|-----|
| 30V   | 16m $\Omega$ | 27A |

## Applications

- DC/DC Converters in Computing, Servers, and POL
- Isolated DC/DC Converters in Telecom and Industrial

## DFN-8 3.3x3.3 Pin Configuration



## Absolute Maximum Ratings

| Symbol                      | Parameter                                  | Rating     | Units            |
|-----------------------------|--------------------------------------------|------------|------------------|
| $V_{DS}$                    | Drain-Source Voltage                       | 30         | V                |
| $V_{GS}$                    | Gate-Source Voltage                        | $\pm 20$   | V                |
| $I_D@T_C=25^\circ\text{C}$  | Continuous Drain Current                   | 27         | A                |
| $I_D@T_C=100^\circ\text{C}$ | Continuous Drain Current                   | 17         | A                |
| $I_{DM}$                    | Pulsed Drain Current                       | 81         | A                |
| EAS                         | Single Pulse Avalanche Energy <sup>1</sup> | 41         | mJ               |
| $P_D@T_C=25^\circ\text{C}$  | Total Power Dissipation                    | 25         | W                |
| $T_{STG}$                   | Storage Temperature Range                  | -55 to 150 | $^\circ\text{C}$ |
| $T_J$                       | Operating Junction Temperature Range       | -55 to 150 | $^\circ\text{C}$ |

## Thermal Data

| Symbol          | Parameter                           | Typ. | Max. | Unit                      |
|-----------------|-------------------------------------|------|------|---------------------------|
| $R_{\theta JA}$ | Thermal Resistance Junction-ambient | ---  | 75   | $^\circ\text{C}/\text{W}$ |
| $R_{\theta JC}$ | Thermal Resistance Junction-case    | ---  | 6    | $^\circ\text{C}/\text{W}$ |

Electrical Characteristics ( $T_J=25^{\circ}\text{C}$  , unless otherwise noted)

| Symbol       | Parameter                         | Conditions                                                 | Min. | Typ. | Max.      | Unit      |
|--------------|-----------------------------------|------------------------------------------------------------|------|------|-----------|-----------|
| $BV_{DSS}$   | Drain-Source Breakdown Voltage    | $V_{GS}=0V$ , $I_D=250\mu A$                               | 30   | ---  | ---       | V         |
| $R_{DS(ON)}$ | Static Drain-Source On-Resistance | $V_{GS}=10V$ , $I_D=6A$                                    | ---  | 13.5 | 16        | $m\Omega$ |
|              |                                   | $V_{GS}=4.5V$ , $I_D=5A$                                   | ---  | 18   | 24        |           |
| $V_{GS(th)}$ | Gate Threshold Voltage            | $V_{GS}=V_{DS}$ , $I_D=250\mu A$                           | 1    | ---  | 2.5       | V         |
| $I_{DSS}$    | Drain-Source Leakage Current      | $V_{DS}=30V$ , $V_{GS}=0V$                                 | ---  | ---  | 1         | $\mu A$   |
|              |                                   | $V_{DS}=24V$ , $V_{GS}=0V$ , $T_J=125^{\circ}\text{C}$     | ---  | ---  | 10        |           |
| $I_{GSS}$    | Gate-Source Leakage Current       | $V_{GS}=\pm 20V$                                           | ---  | ---  | $\pm 100$ | nA        |
| $g_{fs}$     | Forward Transconductance          | $V_{DS}=10V$ , $I_D=15A$                                   | ---  | 7    | ---       | S         |
| $Q_g$        | Total Gate Charge                 | $V_{DS}=15V$ , $I_D=15A$<br>$V_{GS}=4.5V$                  | ---  | 7    | ---       | nC        |
| $Q_{gs}$     | Gate-Source Charge                |                                                            | ---  | 2.7  | ---       |           |
| $Q_{gd}$     | Gate-Drain Charge                 |                                                            | ---  | 3    | ---       |           |
| $T_{d(on)}$  | Turn-On Delay Time                | $V_{DD}=15V$ , $V_{GS}=10V$ , $R_G=3.3\Omega$<br>$I_D=15A$ | ---  | 10   | ---       | ns        |
| $T_r$        | Rise Time                         |                                                            | ---  | 60   | ---       |           |
| $T_{d(off)}$ | Turn-Off Delay Time               |                                                            | ---  | 15   | ---       |           |
| $T_f$        | Fall Time                         |                                                            | ---  | 13   | ---       |           |
| $C_{iss}$    | Input Capacitance                 | $V_{DS}=25V$ , $V_{GS}=0V$ , $f=1\text{MHz}$               | ---  | 800  | ---       | pF        |
| $C_{oss}$    | Output Capacitance                |                                                            | ---  | 80   | ---       |           |
| $C_{rss}$    | Reverse Transfer Capacitance      |                                                            | ---  | 70   | ---       |           |

## Diode Characteristics

| Symbol        | Parameter                        | Conditions                                         | Min. | Typ. | Max. | Unit |
|---------------|----------------------------------|----------------------------------------------------|------|------|------|------|
| $I_S$         | Diode continuous forward current | $V_G=V_D=0V$ , Force Current                       | ---  | ---  | 27   | A    |
| $I_{S,pulse}$ | Diode pulse current              |                                                    | ---  | ---  | 81   | A    |
| $V_{SD}$      | Diode Forward Voltage            | $V_{GS}=0V$ , $I_F=28A$ , $T_J=25^{\circ}\text{C}$ | ---  | ---  | 1.2  | V    |

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